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Please read this notice before using the TAIYO YUDEN products.

## REMINDERS

Product information in this catalog is as of October 2010. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,( automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

  It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
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Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

# **CHIP ANTENNA**





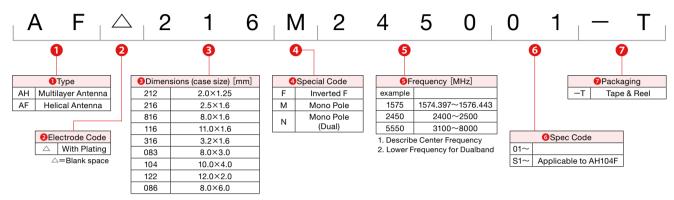
#### **FEATURES**

## APPLICATIONS

- Compact and Low-profile
- Wide bandwidth and High Gain
- Stable temperature characteristics

Bluetooth<sup>®</sup>, Wireless LAN, GPS, WiMAX, ZigBee, UWB

#### ORDERING CODE

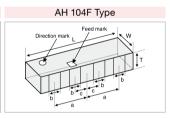


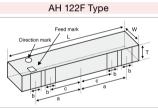
#### **EXTERNAL DIMENSIONS/STANDARD QUANTITY**

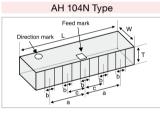














Туре	L	W	Т	E	a	b	С	Standard Quantity (pcs) Embossed Tape	
AF 216M	2.5±0.2	1.6±0.2	1.6±0.2	0.5±0.3	_	_	_		
AF 816M	8±0.2	1.6±0.2	1.6±0.2	0.5±0.3	_	_	_	2000	
AF 116M	11±0.2	1.6±0.2	1.6±0.2	0.5±0.3	_	_	_	1	
AH212M	2 <sup>+0.3</sup> <sub>-0.1</sub>	1.25±0.2	0.85±0.2	0.5±0.3	_	_	_	4000	
AH 316M	3.2±0.15	1.6±0.15	0.5±0.1	0.5±0.2	_	1.0 min.	_	3000	
AH 083F	8±0.3	3±0.3	1±0.3	_	3.1±0.3	1±0.3	1.15±0.3	1000	
AH 104F	10±0.3	4±0.3	1±0.3	_	2.5±0.3	1±0.3	1±0.3		
AH 122F	12±0.3	2±0.3	0.95±0.3	_	5.1±0.3	1±0.3	3.1±0.3	2000	
AH 104N	10±0.3	4±0.3	1±0.3	_	3±0.3	0.8±0.3	1.5±0.3		
AH 086M	8±0.3	6±0.3	1±0.3	_	1.8±0.2	1±0.3	_	1000	

Unit: mm (inch)

#### PART NUMBERS

Applications	Ordering Code	External Dimensions (mm)	Center Frequency (MHz)
	AF 816M157502	8.0×1.6×1.6	1575
GPS	AF 116M157502	11.0×1.6×1.6	1575
	AH 316M157501	3.2×1.6×0.5	1575
	AF 216M245001	2.5×1.6×1.6	2450
	AH 212M245001	2.0×1.25×0.85	2450
W-LAN (2.4GHz)	AH 316M245001	3.2×1.6×0.5	2450
Bluetooth® WiMAX (2.5GHz)	AH 083F245001	8.0×3.0×1.0	2450
ZigBee	AH 104F2450S1	10.0×4.0×1.0	2450
3	AH 104F2650S1	10.0×4.0×1.0	2650
	AH 122F245001	12.0×2.0×0.95	2450
W-LAN(2.4GHz/5GHz)	AH 104N2450D1	10.0×4.0×1.0	2450/5400
UWB & WiMAX(3.5GHz)	AH 086M555003	8.0×6.0×1.0	5550

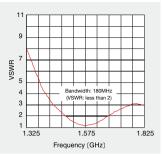
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Vertical polarization Horizontal polarization

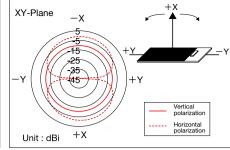
#### Typical Characteristics on Taiyo Yuden evaluation board

#### AF 816M157502



Typical characteristics of VSWR

## ZX-Plane +z4z Vertical polarization Horizontal polarization -zUnit: dBi



Typical characteristics of radiation pattern (@1.575GHz)

XY-Plane

Unit : dBi

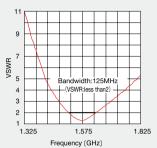
-x

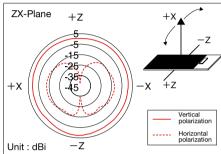
-25 35

45

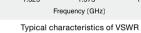
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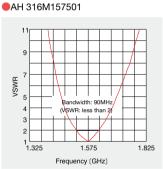
#### ●AH 116M157502



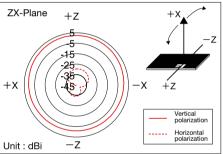


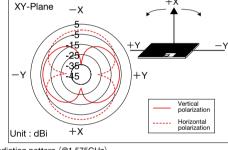
Typical characteristics of radiation pattern (@1.575GHz)





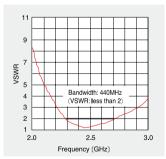
Typical characteristics of VSWR



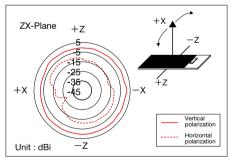


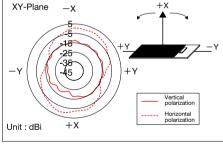
Typical characteristics of radiation pattern (@1.575GHz)

#### AF 216M245001



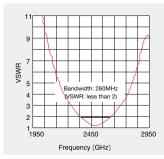
Typical characteristics of VSWR



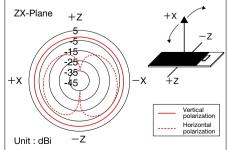


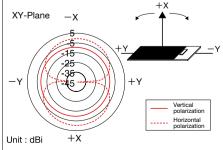
Typical characteristics of radiation pattern (@2.45GHz)

### AH 212M245001



Typical characteristics of VSWR





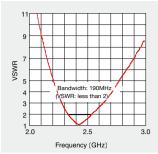
Typical characteristics of radiation pattern (@2.45GHz)

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#### ■ ELECTRICAL CHARACTERISTICS TYPICAL CHARACTERISTICS

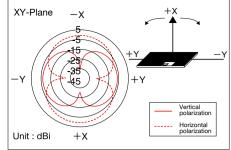
Typical Characteristics on Taiyo Yuden evaluation board

#### AH 316M245001



Typical characteristics of VSWR

## 



Horizontal polarization

Vertical polarization

Typical characteristics of radiation pattern (@2.45GHz)

XY-Plane

Unit : dBi

XY-Plane

Unit : dBi

-x

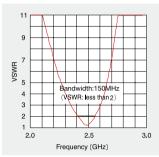
-45

+x

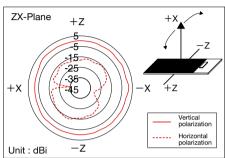
-x

15

#### AH 083F245001

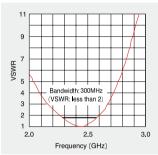


Typical characteristics of VSWR

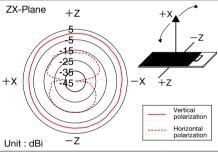


Typical characteristics of radiation pattern (@2.45GHz)

#### AH 104F2450S1

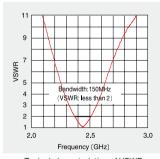


Typical characteristics of VSWR

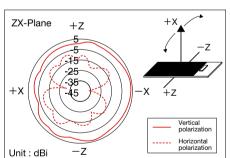


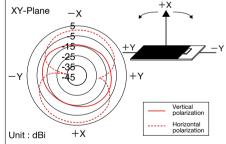
Typical characteristics of radiation pattern (@2.45GHz)

#### AH 122F245001



Typical characteristics of VSWR





Typical characteristics of radiation pattern (@2.45GHz)

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ZX-Plane

+x

+z

45

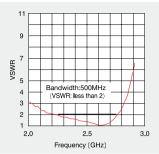
-z

Unit : dBi

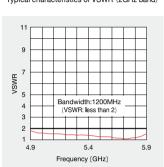
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#### Typical Characteristics on Taiyo Yuden evaluation board

#### ●AH 104N2450D1



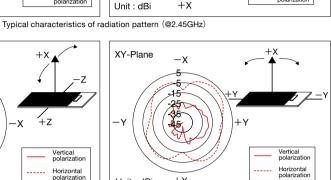
Typical characteristics of VSWR (2GHz band)



Typical characteristics of VSWR (5GHz band)

## Vertical polarization Horizontal polarization -zUnit : dBi ZX-Plane +z-25 35 / +z

/ +z



+x

Vertical polarization

+٧

Typical characteristics of radiation pattern (@5.25GHz)

Unit : dBi

Vertical polarization

Horizontal polarization

XY-Plane

-x

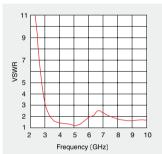
15

-25

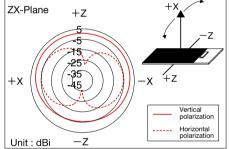
+x

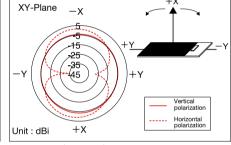
+x

#### AH 086M555003



Typical characteristics of VSWR





Typical characteristics of radiation pattern (@3.96GHz)

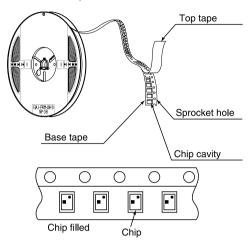
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#### **1**Minimum Quantity

Туре	Standard Quantity (pcs) Embossed Tape
AF216M, AF816M, AF116M, AH104F, AH122F, AH104N	2000
AH316M	3000
AH083F, AH086M	1000
AH212M	4000

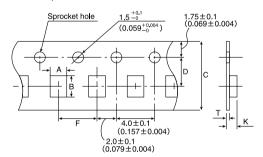
#### **2**Tape Material

#### Embossed Tape

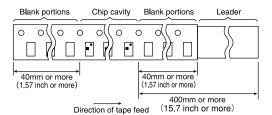


#### **3**Taping Dimensions

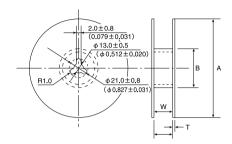
#### Embossed Tape



#### **4** Leader and Blank Portion



#### **5**Reel size

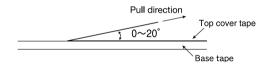


Туре	А	В	W	Т
AF216M, AH212M	178±2.0	50 min.	10.0±1.5	3.0 max.
AH316M	(7.0±0.08)	(2.0 min.)	(0.394±0.06)	(0.12 max.)
AF816M	178±2.0	50 min.	17.0±1.0	2.5 max.
AH083F	(7.0±0.08)	(2.0 min.)	(0.67±0.04)	(0.1 max.)
AF116M, AH104F	330±2.0	100±1.0	25.5±1.0	3.0 max.
AH122F, AH104N	(13.0±0.08)	(3.94±0.04)	(1.0±0.04)	(0.12 max.)
AH086M	330 ± 2.0	100 ± 1.0	17.0 ± 1.0	2.5 max.
	(13.0±0.08)	(3.94±0.04)	(0.67±0.04)	(0.1 max.)

Unit : mm (inch)

#### **6**Top Tape Strength

The top tape requires a peel-off force of  $0.1 \sim 0.7 N$  in the direction of the arrow as illustrated below.



Time	Chip Cavity		Tape Widthness		Insertion Pitch Tape Thickne		iess MAX.
Type	Α	В	С	D	F	K	Т
AF216M	1.85±0.2	2.75±0.2	8±0.2	3.5±0.1	4±0.1	1.95	0.3
	(0.073±0.008)	(0.108±0.008)	(0.315±0.008)	(0.138±0.004)	(0.157±0.004)	(0.077)	(0.012)
AF816M	1.95±0.2	8.4±0.2	16±0.3	7.5±0.1	4±0.1	2.05	0.35
	(0.077±0.008)	(0.331±0.008)	(0.630±0.012)	(0.296±0.004)	(0.157±0.004)	(0.081)	(0.014)
AF116M	1.95±0.2	11.4±0.2	24±0.3	11.5±0.1	4±0.1	2.05	0.35
	(0.077±0.008)	(0.449±0.008)	(0.945±0.012)	(0.453±0.004)	(0.157±0.004)	(0.081)	(0.014)
AH316M	1.9±0.2	3.5±0.2	8±0.2	3.5±0.1	4±0.1	0.85	0.3
	(0.075±0.008)	(0.138±0.008)	(0.315±0.012)	(0.138±0.004)	(0.157±0.004)	(0.033)	(0.012)
AH083F	3.35±0.2	8.35±0.2	16±0.3	7.5±0.1	8±0.1	1.55	0.3
	(0.132±0.008)	(0.329±0.008)	(0.630±0.012)	(0.295±0.004)	(0.315±0.004)	(0.061)	(0.012)
AH104F,	4.35±0.2	10.35±0.2	24±0.3	11.5±0.1	8±0.1	1.55	0.3
AH104N	(0.171±0.008)	(0.407±0.008)	(0.945±0.012)	(0.435±0.004)	(0.315±0.004)	(0.061)	(0.012)
AH122F	2.3±0.2	12.3±0.2	24±0.3	11.5±0.1	4±0.1	1.45	0.35
	(0.091±0.008)	(0.484±0.008)	(0.945±0.012)	(0.435±0.004)	(0.157±0.004)	(0.057)	(0.014)
AH086M	6.25±0.2	8.26±0.2	16±0.3	7.5±0.1	12±0.1	1.3	0.3
	(0.246±0.008)	(0.325±0.008)	(0.630±0.012)	(0.296±0.004)	(0.473±0.004)	(0.051)	(0.012)
AH212M	1.5±0.2	2.3±0.2	8±0.3	3.5±0.1	4±0.1	1.5	0.3
	(0.059±0.008)	(0.091±0.008)	(0.315±0.012)	(0.138±0.004)	(0.157±0.004)	(0.059)	(0.012)

Unit: mm (inch)

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#### RELIABILITY DATA

Operating Temperature Range	
Specified Value	_20~+80°C
2. Storage Temperature Range	
Specified Value	-40~+85℃
[Test Methods and Remarks]	
3. Solderability	
Specified Value	At least 90% of immersed terminal surface is covered by new solder.
[Test Methods and Remarks] Solder temperature: 230±5°C Duration: 3±1 sec. Preconditioning: Preheating at 150°C after immersion	into flux.
4. Thermal Shock	
Specified Value	Shall satisfy required VSWR value of individual specifications for each item.
[Test Methods and Remarks] 1 hour of recovery after 10 times of 30min.immersion alter	rnately at $-40^{\circ}$ C and 85°C of temperature,followed by evaluating electrical characteristics.
5. High Temperature Storage Test	
Specified Value	Shall satisfy required VSWR value of individual specifications for each item.
[Test Methods and Remarks] 1 hour of recovery under standard condition after 96 hour	s recovery with 85°C of temperature, followed by evaluating electrical characteristics.
6. Low Temperature Storage Test	
Specified Value	Shall satisfy required VSWR value of individual specifications for each item.
[Test Methods and Remarks] 1 hour of recovery under standard condition after 96 hour	s recovery with $-40^{\circ}$ C of temperature, followed by evaluating electrical characteristics.
7. Humidity Storage Test	
Specified Value	Shall satisfy required VSWR value of individual specifications for each item.
[Test Methods and Remarks] 1 hour of recovery under standard condition after 96 hour	s recovery with 60°C of temperature, 90~95% relative humidity followed by evaluating electrical characteristics.
8. Resistance to Reflow	
Specified Value	Shall satisfy required VSWR value of individual specifications for each item.
[Test Methods and Remarks] Two times of reflow soldering by recommended profile att	ached, followed by evaluating electrical characteristics.

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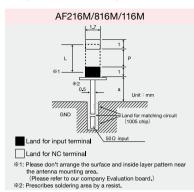
#### 1. PCB Design

#### Precautions

◆Land pattern design
Please do not arrange the surface and inside layer pattern near the antenna mounting area.

◆Land pattern design

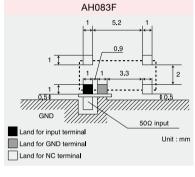
Land pattern dimension examples and recommended antenna land pattern

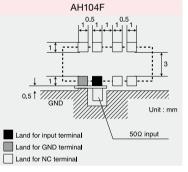


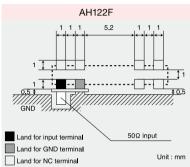
Type	Dimensions			
туре	L	Р	а	
AF216M	2.5	1.5	3	
AF816M	8	7	5	
AF116M	11	10	3	
AH212M	2	1	3	
			Unit : mm	

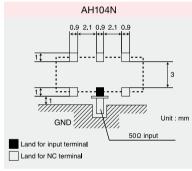
AH316M GND Unit: mm matching circuit (1005 chip) Land for input termina 50Ω input Land for GND terminal

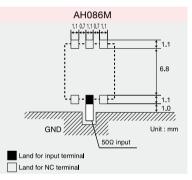
Technical Considerations











#### 2. Soldering

◆Conditions of Reflow soldering (for reference)

Technical Considerations

- · Pb Free Reflow Profile Reflow Soldering 300 Peak 260°C max 200 100 Preheating 150°C Heating above 230°C 40sec max 60sec min Duration (seconds)
- temperature pattern of reflow furnace temperature 250 215℃ 200 150 100

20~30

Duration(seconds)

 Components should be preheated to within 100 to 130℃ from soldering temperature. \* Assured to be reflow soldering for 2 times.

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

#### 3. Storage Conditions

- Storage conditions
- The Products should not be used in the following environments:
   exposure to special gases such as (C12, NH3, SOx, NOx)

  - exposure to volatile gas or inflammable gas
    exposure to a lot of dust
- Precautions
- exposure to water or condensation
- exposure to direct sanlight or freezing 2. The Products should be kept in the following conditions:
  - Temperature: -10~+40°C
    Humidity: 15~85%RH
- 3. The products should be used within 6 months after delivery. In case of storage over 6 months, solderability shall be checked before actual usage.

about 60 55~75

■ Please contact our offices for further details of specifications.

All of the standard values listed here are subject to change without notice due to technical improvements.

Therefore, please check the specifications carefully before use.

· Reflow profile

<sup>\*</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.